# 2SD2565

## Silicon NPN triple diffusion planar type

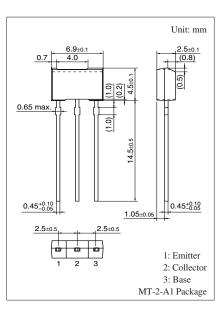
For high voltage-withstand switching

#### Features

- High collector-base voltage (Emitter open) V<sub>CBO</sub>
- High collector-emitter voltage (Base open)  $V_{CEO}$
- Large collector power dissipation P<sub>C</sub>
- $\bullet$  Low collector-emitter saturation voltage  $V_{\mbox{CE(sat)}}$
- M type package allowing easy automatic and manual insertion as well as stand-alone fixing to the printed circuit board.

Absolute Maximum hatings $T_a = 25$ C							
Parameter	Symbol	Rating	Unit				
Collector-base voltage (Emitter open)	V <sub>CBO</sub>	400	V				
Collector-emitter voltage (Base open)	V <sub>CEO</sub>	400	V				
Emitter-base voltage (Collector open)	V <sub>EBO</sub>	5	V				
Collector current	I <sub>C</sub>	0.5	А				
Peak collector current	I <sub>CP</sub>	1	А				
Collector power dissipation *	P <sub>C</sub>	1	W				
Junction temperature	Tj	150	°C				
Storage temperature	T <sub>stg</sub>	-55 to +150	°C				

#### Absolute Maximum Ratings $T_a = 25^{\circ}C$



Note) \*: Printed circuit board: Copper foil area of 1 cm<sup>2</sup> or more, and the board thickness of 1.7 mm for the collector portion

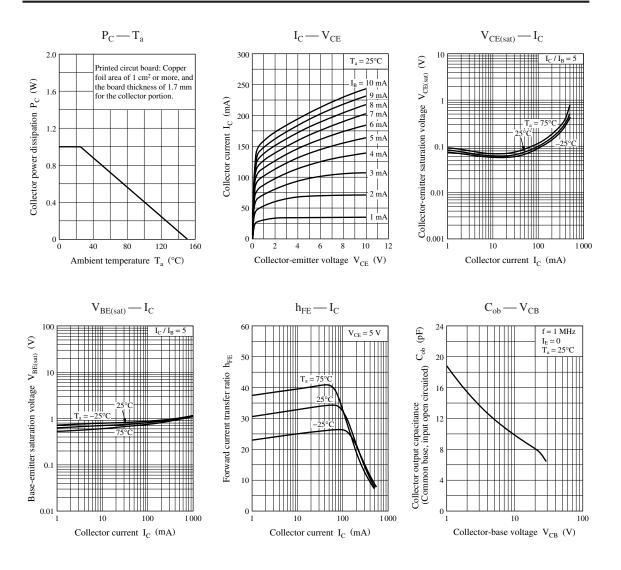
## Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-base voltage (Emitter open)	V <sub>CBO</sub>	$I_{C} = 100 \ \mu A, \ I_{E} = 0$	400			V
Collector-emitter voltage (Base open)	V <sub>CEO</sub>	$I_{C} = 500 \ \mu A, I_{B} = 0$	400			V
Emitter-base voltage (Collector open)	V <sub>EBO</sub>	$I_E = 100 \ \mu A, \ I_C = 0$	5			V
Forward current transfer ratio	h <sub>FE</sub>	$V_{CE} = 5 \text{ V}, \ I_C = 30 \text{ mA}$	30			
Collector-emitter saturation voltage *	V <sub>CE(sat)</sub>	$I_{\rm C} = 250 \text{ mA}, I_{\rm B} = 50 \text{ mA}$			1.5	V
Base-emitter saturation voltage *	V <sub>BE(sat)</sub>	$I_{\rm C} = 250 \text{ mA}, I_{\rm B} = 50 \text{ mA}$			1.5	V
Transition frequency	f <sub>T</sub>	$V_{CB} = 30 \text{ V}, I_E = -20 \text{ mA}, f = 200 \text{ MHz}$		30		MHz
Collector output capacitance (Common base, input open circuited)	C <sub>ob</sub>	$V_{CB} = 30 \text{ V}, I_E = 0, f = 1 \text{ MHz}$		6	20	pF
Turn-on time	t <sub>on</sub>	I <sub>C</sub> = 100 mA		0.8		μs
Storage time	t <sub>stg</sub>	$I_{B1} = 10 \text{ mA}, I_{B2} = -10 \text{ mA}$		3.7		μs
Fall time	t <sub>f</sub>	$V_{CC} = 200 V$		0.6		μs

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

2. \*: Pulse measurement

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